# MSKSEMI 美森科













**ESD** 

1/5

rss –

MOV

GDT

PIFD

# **PESD1IVNXX-AX-MS**

**Product specification** 





#### **FEATURES**

- IEC61000-4-2 (ESD) ±15kV (air), ±8kV (contact) IEC61000-4-4 (EFT) 40A (5/50ηs)
- 350 Watts Peak Pulse Power per (tp=8/20μs)
   Protects one I/O line (bidirectional)
- Low clamping voltage
- Working voltages :
- 3V,5V,8V,12V,15V,18V,20V,24V,36V
- Low leakage current

#### **MACHANICAL DATA**

- SOD-323 package
- Flammability Rating: UL 94V-0
- Packaging: Tape and Reel
- High temperature soldering guaranted:260C/10s
- Reel size: 7 inch
- MSL 1

#### **APPLICATIONS**

- Cell Phone Handsets and Accessories
- Microprocessor based equipment
- Personal Digital Assistants (PDA's)
- Notebooks, Desktops, and Servers
- Portable Instrumentation
- Networking and Telecom
- Serial and Parallel Ports.
- Peripherals

#### **Reference News**

PACKAGE OUTLINE	PIN CONFIGURATION
SOD-323	

# Marking for the PESD1IVNXX-AX-MS series

VRWM	3.3V	5V	8V	12V	15V	18V	20V	24V	36V
Marking	2A	2B	2C	2D	2J	2K	2L	2H	2N



## **ABSOLUTE MAXIMUM RATING**

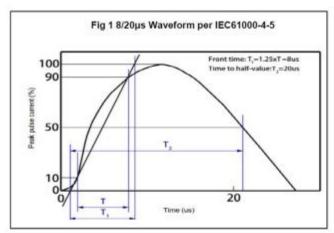
Symbol	Parameter	Value	Units
VESD	ESD per IEC 61000-4-2 (Air)		14) /
AE2D	ESD per IEC 61000-4-2 (Contact)	±8	kV
PPP	Peak Pulse Power (8/20μs)	350	W
TOPT	Operating Temperature	-55/+150	°C
TSTG	Storage Temperature	-55/+150	${\mathbb C}$
TL	Lead Soldering Temperature	260 (10 sec.)	$^{\circ}$ C

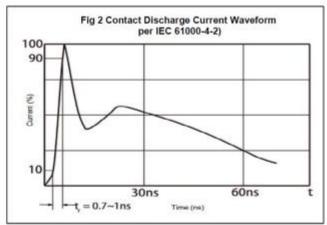
# **ELECTRICAL CHARACTERISTICS (Tamb=25℃)**

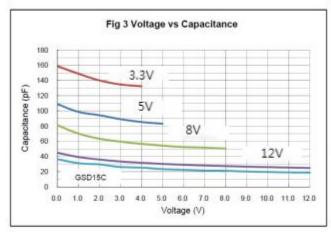
PART	VRWM (V)	VB (V)	lŢ (mA)	VC@1A (V)		/c	IR (μA)	CT (pF)
NUMBER	(max.)	(min.)		(max.)	(V) (max.)		(max.)	(max.)
					(@	<b>A</b> )		
PESD1IVN3.3-AX-MS	3.3	4.0	1	7.5	16.0	20	40	450
PESD1IVN05-AX-MS	5.0	6.0	1	9.8	18.0	17	10	200
PESD1IVN08-AX-MS	8.0	8.5	1	13.4	24.0	15	2	120
PESD1IVN12-AX-MS	12.0	13.3	1	19.0	32.0	11	1	75
PESD1IVN15-AX-MS	15.0	16.7	1	24.0	38.0	10	1	68
PESD1IVN18-AX-MS	18.0	20.0	1	29.0	45.0	9	1	57
PESD1IVN20-AX-MS	20.0	22.3	1	35.0	50.0	8	1	52
PESD1IVN24-AX-MS	24.0	26.7	1	43.0	52.0	7	1	50
PESD1IVN36-AX-MS	36.0	40.0	1	60.0	75.0	4.5	1	35

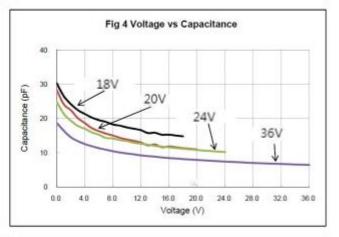


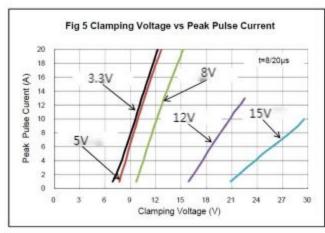
## **ELECTRICAL CHARACTERISTICS CURVE**

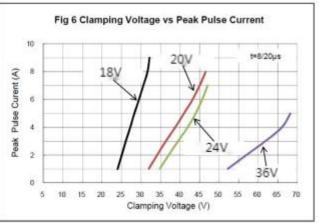






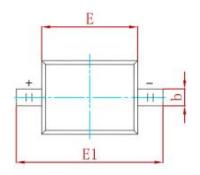


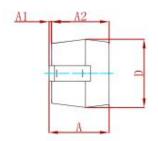


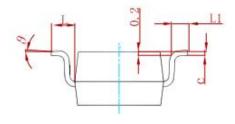




## PACKAGE MECHANICAL DATA

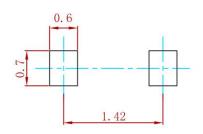






Symbol	Dimensions	n Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α		1.000		0.039	
A1	0.000	0.100	0.000	0.004	
A2	0.800	0.900	0.031	0.035	
b	0.250	0.350	0.010	0.014	
С	0.080	0.150	0.003	0.006	
D	1.200	1 .400	0.047	0.055	
E	1.600	1 .800	0.063	0.071	
E1	2.550	2.750	0.100	0.108	
L	0.475	REF.	0.019 REF.		
L1	0.250	0.400	0.010	0.016	
е	0°	8°	0°	8°	

# **Suggested Pad Layout**



#### Note:

- 1.Controlling dimension:in millimeters.
- 2.General tolerance:± 0.05mm.
- 3. The pad layout is for reference purposes only.

## **REEL SPECIFICATION**

P/N	PKG	QTY
PESD1IVNXX-AX-MS	SOD-323	3000



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